Reliable, Ruggedized, High-Performance Computing

Introduction

PACSystems RXi2 IPCs offer a range of processor choices, increased and faster storage, improved graphics, and enhanced security features.

The PACSystems RXi2-UP IPC delivers rugged, high- performance computing capabilities to run HMI, historian, and analytics applications right at the machine, to enable improved real-time control of operations and better integration into plant-wide systems.

Combining outstanding computing capabilities with the added expandability of 1, 2 or 4 PCI Express slots and CFast storage, the PACSystems RXi2-UP is ideal for a range of demanding industrial applications.



The PACSystems RXi2-UP IPC has high-performance Intel Xeon processors, up to 32GB of ECC RAM, 5 Gigabit Ethernet interfaces, and industrial grade SSD disk storage to complete the high-performance design.

It provides additional application flexibility with both, mini PCI Express and low-profile PCI Express slots. This expandability combined with advanced CPUs delivers high-performance, computing.

PACSystems RXi2-UP IPC incorporates patented thermal monitoring technology with sophisticated passive cooling techniques to provide the highest performance, fanless industrial edge computing platform. So, it can operate at peak computing performance in extended temperature ranges right at the machine, without having to throttle the CPU.

Pre-Loaded Edge Analytics and SCADA

Do more at the edge with the PACSystems RXi2-UP optionally pre-loaded with Emerson's Movicon.NExT HMI/SCADA software. This industrial PC delivers a powerful and tightly integrated solution with reliable, industrial computing and innovative, scalable and flexible automation software. Based on OPC UA, Movicon.NExT is the first integrated automation software platform for connectivity, IIoT, machine HMI, HMI/SCADA and plant analytics.



Movicon.NExT enables connectivity to many native and integrated communication protocols. It provides enhanced visualization tools, including WPF, XAML and 3D graphics, and also enables data recording independent of data format used. With Movicon.NExT, users also get integrated scripting, an alarm management system, and analytics capable of acquiring production data in real time. These analytics provide KPI and OEE performance data, calculate machine downtime and can be used in tracking and scheduling production.

Greater Uptime

All aspects of the PACSystems RXi2-UP IPC have been engineered for reliability in harsh industrial environments, from the use of all industrial grade components to its fanless design. To help keep data and operations secure, the PACSystems RXi2-UP utilizes Trusted Platform Module (TPM) and Microsoft Secure Boot technology. Security coupled with PACSystems RXi2-UP's strong shock and vibration resistance and available RAID storage options keeps your data protected and maximizes uptime.

For more information: www.Emerson.com/PACSystems





Enhanced Productivity & Lower Total Cost of Ownership (TCO)

The PACSystems RXi2-UP IPC combines high performance with reliability, enhancing productivity and reducing total cost of ownership.

The PACSystems RXi2-UP IPC delivers low TCO through features such as compact size, reduced maintenance, low power consumption, and ease of future performance upgrades enabled by our innovative rugged COM Express CPU architecture.

Feature	Benefit
7th Generation Intel® Xeon® CPUs	Delivers high-performance computing for applications that load, manipulate and store large amounts of data, or handle multiple communication ports in real-time.
Fanless operation	A robust, reliable solution with no moving parts and minimized dust contamination.
5 Gigabit ethernet ports (Four with Time SYNC IEEE1588 and 802.1AS)	Network implementation flexibility. Multiple high-speed Ethernet links for communication-centric applications with support for deterministic transfer of data/commands.
0, 1, 2 or 4 PCIe expansion slots	Add new functionality on demand to support specific application needs.

Specifications

Processor	
	Intel® XEON® Processor E3-1505M v6, 35/45W 4c8t 3.0GHz (-4.0GHz) 8MB
7th Generation Intel® Xeon®	Intel® XEON Processor E3-1505L v6, 25W 4c8t 2.2GHz (-3.0GHz) 8MB
	Intel® XEON® Processor E3-1501M v6, 45W 4c4t 2.9GHz (-3.6GHz) 6MB
Memory	
	Up to 32GB DDR4-2400
	Soldered, with ECC
Storage Interfaces	
	Primary storage device – M.2 SATA Gen3 (User-installed M.2 NVMe SSD supported)
	Secondary storage option – Twin 2.5" SATA drive bays, hot swap and RAID (0 or 1 configuration) enabled on specific SKUs.
	CFast slot, user accessible, supports boot, hot plug
Ethernet	
	Four 1-gigabit Ethernet channels – RJ-45 standard
	One 1-gigabit Ethernet channel w/ remote management capability, Intel's AMT – RJ45

¹ Additional features may be added by customization, please contact your regional sales representative to inquire.

² Operating temperature is dependent on the CPU and SSD choice, application software, orientation of the heat sink fins at free convection. For detailed recommendations please refer to Hardware Reference Manual or contact support team.

Wireless Communication				
	User-installed and certified LTE mo	odem capability using mini-PCIe with U	IM card holder	
	User-installed Wifi/Bluetooth radio (FCC certified module required)	capability using M.2 or mini-PCIe or Po	CIe expansion slot	
Graphics Interface				
	Twin DisplayPort++ 1.2 for a total of	of 3 independent displays for up to 4K r	esolution	
USB Interface				
	Four USB 3.0 external			
	Two USB 2.0 internal	Two USB 2.0 internal		
Serial Communications	1			
	2 to 4 channels			
	Two RS232, two RS422/485 depend	ding on SKU		
Expansion				
	Mini-PCIE card site for user-installed/certified NvSRAM, WiFi, Bluetooth, LTE modem card or other M.2 communications slot for user-installed WiFi and Bluetooth			
	PCI Express expansion slots: - Zero - One Gen3 x4 - Two Gen2 x4 - Four: 1 slot Gen2 x4 and 3 slots	s Gen2 x1		
LED	· 			
	LED indictors: Power, TPM, Temper	ature, SATA		
	Ethernet Link/Activity			
	One User Defined LED			
Others				
	Timers: Legacy PC-AT, HPET			
	Twin Watchdog Timers (OS, application	ation)		
	Holistic, system-level, thermal monitoring			
	RTC with Lithium coin cell battery			
Power				
	Input: 24V DC (±25%) with surge protection			
F	Maximum current: 3.5A			
Environmental				
All values under typical conditions without added expansion slot cards. Extended	Range	Operating ²	Storage	
emperature variants are available upon request. The maximum extended temperature	Standard	0°C up to +70°C	-40°C up to +85°C	
ranges mentioned in the table below are achievable with a specific choice of CPU and	Extended	-40°C up to +70°C ²	-40°C up to +85°C	
storage, and without extension cards installed in the system.	Humidity	5-95% @ +40°C	5-95% @ +40°C	
For detailed information please read the manual.	Altitude	6,600 ft. (2.0 km)	40000 ft. (12 km)	
Firmware				
	UEFI AMI Aptio® 5			

¹ At 100% CPU load temperature range requires vertical orientation of the heat sink fins at free convection.
² Operating temperature is dependent on the CPU and SSD choice, application software, orientation of the heat sink fins at free convection.

For detailed recommendations please contact support team.

³ Extended Temperature Range available upon request.

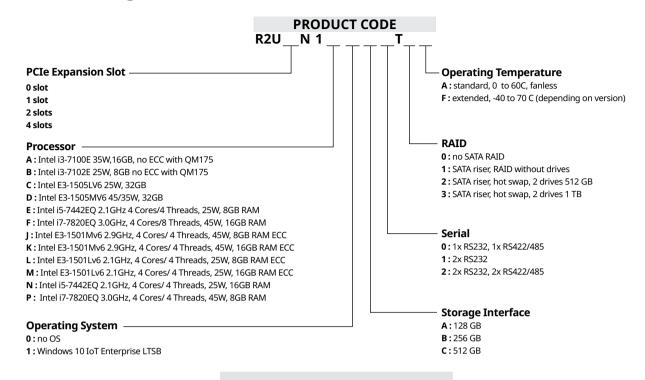
⁴ RAID when using HDD (v.s. SSD) Drives brings Operating Temperature limits down to a maximum of 40°C depending on chosen HDD and HDD workload.

Mechanical		
	Rugged aluminum and stainless-steel housing for optimal thermal management and durability	
	IP20 – Protection against particles	
	Flat and Slim (Book) mounting orientation options	
Software Support		
	Microsoft® Windows® 10 IoT 2019 LTSC	
	Linux® Kernel 4.9 (not pre-loaded)	
	VxWorks® 7.0 (not pre-loaded)	
	Movicon.NExT 4.1 and above (pre-loaded options available)	
	Pro.Lean™ (pre-loaded options available)	
Safety & EMC		
	IEC/UL62368	
	CE, FCC	
Dimensions (H x W x D)		
Dimensions	0-slot: 252 x 203 x 108.5 mm (9.92 x 8 x 4.24 in)	
	1-slot: 252 x 203 x 135.5 mm (9.92 x 8 x 5.33 in)	
	2-slot: 252 x 203 x 155.5 mm (9.92 x 8 x 6.13 in)	
	4-slot: 252 x 203 x 195.5 mm (9.92 x 8 x 7.70 in)	
Weight	0-slot: 3.9 kg (8.60 lbs)	
	1-slot: 4.2 kg (9.26 lbs)	
	2-slot: 4.4 kg (9.70 lbs)	
	4-slot: 4.7 kg (10.34 lbs)	

¹ Additional features may be added by customization, please contact your regional sales representative to inquire.

² Operating temperature is dependent on the CPU and SSD choice, application software, orientation of the heat sink fins at free convection. For detailed recommendations please refer to Hardware Reference Manual or contact support team.

Understanding Part Number Nomenclature



Example: R2U 2 N 1 D 0 B 2 T 0 F

Ordering Information

Part Number	Description	Operating Temperature
R2U0N1B0A1T0A	RXi2-UP IPC, Dual Core i3-7102E, 2.1GHz, 0 Slot, 128GB SSD, 8GB DDR4, 2xRS232, 5xRJ45, No OS	0°C up to +60°C
R2U0N1B1A1T0A	RXi2-UP IPC, Dual Core i3-7102E, 2.1GHz, 0 Slot, 128GB SSD, 8GB DDR4, 2xRS232, 5xRJ45, Windows 10	0°C up to +60°C
R2U0N1E0A1T0A	RXi2-UP IPC, Quad Core i5-7442EQ, 2.1GHz, 0 Slot, 128GB SSD, 8GB DDR4, 2xRS232, 5xRJ45, No OS	0°C up to +60°C
R2U0N1E1A1T0A	RXi2-UP IPC, Quad Core i5-7442EQ, 2.1GHz, 0 Slot, 128GB SSD, 8GB DDR4, 2xRS232, 5xRJ45, Windows 10	0°C up to +60°C
R2U0N1J0B1T0A	RXi2-UP IPC, Quad Core XEON E3-1501M, 2.9GHz, 0 Slot, 256GB SSD, 8GB DDR4 ECC, 2xRS232, 5xRJ45, No OS,	0°C up to +60°C
R2U0N1J1B1T0A	RXi2-UP IPC, Quad Core XEON E3-1501M, 2.9GHz, 0 Slot, 256GB SSD, 8GB DDR4 ECC, 2xRS232, 5xRJ45, Windows 10	0°C up to +60°C
R2U1N1B0A1T0A	RXi2-UP IPC, Dual Core i3-7102E, 2.1GHz, 1 Slot, 128GB SSD, 8GB DDR4, 2xRS232, 5xRJ45, No OS	0°C up to +60°C
R2U1N1B1A1T0A	RXi2-UP IPC, Dual Core i3-7102E, 2.1GHz, 1 Slot, 128GB SSD, 8GB DDR4, 2xRS232, 5xRJ45, Windows 10	0°C up to +60°C
R2U1N1E0A1T0A	RXi2-UP IPC, Quad Core i5-7442EQ, 2.1GHz, 1 Slot, 128GB SSD, 8GB DDR4, 2xRS232, 5xRJ45, No OS	0°C up to +60°C
R2U1N1E1A1T0A	RXi2-UP IPC, Quad Core i5-7442EQ, 2.1GHz, 1 Slot, 128GB SSD, 8GB DDR4, 2xRS232, 5xRJ45, Windows 10	0°C up to +60°C
R2U1N1J1B1T0A	RXi2-UP IPC, Quad Core XEON E3-1501M, 2.9GHz, 1 Slot, 256GB SSD, 8GB DDR4 ECC, 2xRS232, 5xRJ45, Windows 10	0°C up to +60°C

Ordering Information

Part Number	Description	Operating Temperature
R2U1N1F1A1T0A	RXi2-UP IPC, Quad Core i7-7820EQ, 3.0GHz, 1 Slot, 128GB SSD, 16GB DDR4, 2xRS232, 2xRS422/485, 5xRJ45, Windows 10	0°C up to +60°C
R2U1N1C0A1T0A	RXi2-UP IPC, Quad Core XEON E3-1505Lv6, 2.2GHz, 1 Slot, 128GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, No OS	0°C up to +60°C
R2U1N1C1A1T0A	RXi2-UP IPC, Quad Core XEON E3-1505Lv6, 2.2GHz, 1 Slot, 128GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, Windows 10	0°C up to +60°C
R2U2N1J1B2T0A	RXi2-UP IPC, Quad Core XEON E3-1501M, 2.9GHz, 2 Slot, 256GB SSD, 8GB DDR4 ECC, 2xRS232, 5xRJ45, Windows 10	0°C up to +60°C
R2U2N1F1A2T0A	RXi2-UP IPC, Quad Core i7-7820EQ, 3.0GHz, 2 Slot, 128GB SSD, 16GB DDR4, 2xRS232, 2xRS422/485, 5xRJ45, Windows 10	0°C up to +60°C
R2U2N1D0A2T0A	RXi2-UP IPC, Quad Core XEON E3-1505Mv6, 3.0GHz, 2 Slot, 128GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, No OS	0°C up to +60°C
R2U2N1D1A2T0A	RXi2-UP IPC, Quad Core XEON E3-1505Mv6, 3.0GHz, 2 Slot, 128GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, Windows	0°C up to +60°C
R2U2N1C0B2T0F	RXi2-UP IPC, Quad Core XEON E3-1505Lv6, 2.2GHz, 2 Slot, 256GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, No OS	-40°C up to +70°C
R2U2N1C1B2T0F	RXi2-UP IPC, Quad Core XEON E3-1505Lv6, 2.2GHz, 2 Slot, 256GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, Windows 10	-40°C up to +70°C
R2U4N1F0A2T0A	RXi2-UP IPC, Quad Core i7-7820EQ, 3.0GHz, 4 Slot, 128GB SSD, 16GB DDR4, 2xRS232, 2xRS422/485, 5xRJ45, No OS	0°C up to +60°C
R2U4N1F1A2T0A	RXi2-UP IPC, Quad Core i7-7820EQ, 3.0GHz, 4 Slot, 128GB SSD, 16GB DDR4, 2xRS232, 2xRS422/485, 5xRJ45, Windows 10	0°C up to +60°C
R2U4N1C0B2T0A	RXi2-UP IPC, Quad Core XEON E3-1505Lv6, 2.2GHz, 4 Slot, 256GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, No OS	0°C up to +60°C
R2U4N1C1B2T0A	RXi2-UP IPC, Quad Core XEON E3-1505Lv6, 2.2GHz, 4 Slot, 256GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, Windows 10	0°C up to +60°C
R2U4N1D0C2T0A	RXi2-UP IPC, Quad Core XEON E3-1505Mv6, 3.0GHz, 4 Slot, 512GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, No OS	0°C up to +60°C
R2U4N1D1C2T0A	RXi2-UP IPC, Quad Core XEON E3-1505Mv6, 3.0GHz, 4 Slot, 512GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, Windows 10	0°C up to +60°C
R2U2N1C1A1T1A	RXi2-UP IPC, Quad Core XEON E3-1505Lv6, 2.2GHz, 2 Slot, 128GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, Windows 10, RAID	0°C up to +60°C
R2U4N1D1A2T1A	RXi2-UP IPC, Quad Core XEON E3-1505Mv6, 3.0GHz, 4 Slot, 128GB SSD, 32GB DDR4 ECC, 2xRS232, 2xRS422/485, 5xRJ45, Windows 10, RAID	0°C up to +60°C

Pre-Loaded Software Devices

Part Number	Description	Operating Temperature
R2U2N1D3B1T1F	RXi2-UP Industrial PC: Intel® E3-1505Mv6 CPU, 32GB RAM, 256GB SSD, RAID, 2 PCIe Slots, No Drives, -40 to 70C, Windows, Movicon.Next, Alarm Dispatcher, Web Client, PRO.LEAN, 20000 Tags	-40°C up to +70°C